



Spec. No: Date:

Product Specification

CustomerName :PartDesctription :Customer Part No. :XiangyeePart No. :

[For Customer approval O	Date:		
Qualification Status:	Full	□Rejected	
Approved By	Verified By	Check By	
Comments:			

Approved By	Checked By	Issued By
Xiaohong Qu	Hu Liu	Yuchun Lai





[Version change history]

01	2016-4-7	New release	Yuchun Lai





1、 Scope

This specification applies to CA42 series of Chip Tantalum Capacitors.

2、 Reference

GJB 360A-96	Test methods for electronic and electrical component parts
IEC384-3-1	Test Methods for Environmental Testing
QJ/PWV61-2002	CA42 Series Operating Standard

3. Product Description and Identification (Part Number)

3.1 Description

CA42 Series of resin dipped solid tantalum capacitors.

3.2 Product Identification (Part Number)



3.3 Markings



Capacitance (µF)	0.1	0.15	0.22	0.33	0.47	0.68	1.0	1.5	2.2	3.3	4.7	6.8	10
Code	104	154	224	334	474	684	105	155	225	335	475	685	106
Capacitance (µF)	15	22	33	47	68	100	220	330	470	680			
Code	156	226	336	476	686	107	227	337	477	687			





4. Electrical Characteristics

Please refer to Appendix A

- 1) Operating and storage temperature range (individual chip without packing): $-55C^{\circ} + 105C^{\circ}$
- 2) Storage temperature range (packaging conditions): -10C°~+40C°, RH70% (MAX).

5、 Shape and Dimensions



6、 Construction







7、 Performance

Unless other specified, the standard atmospheric conditions for measurement/test as: a, Ambient Temperature: 25 ± 10 C°b; Relative Humidity: $50\pm30\%70\%$; c, Air Pressure: 86KPa ~ 106 KPa.

No.	ltem	Performance	Test or Inspection method
1	Visual Examinations	No defects which may affect performance.	Inspection Equipment: 20X magnifier
2	Capacitance (C _R)	Within the specified tolerance.	a. Test frequency :100±5Hz,.
			b. Test equipment: HP4263B or equal capacitance
			tester.
			c. Test signal: 1000mV.
3	Dissipation Factor	Meet the spec	a. Test frequency: 100±5Hz.
	(DF or tgσ)	(Defects Annendiv A)	b. Test equipment: HP4263B or equal capacitance
			tester.
			c. Test signal: 1000mV.
4	Equivalent Series	Meet the spec	a. Test frequency: 100±5KHz,.
	Resistance (ESR)	(Poferto Annendix A)	b. Test equipment (Analyzer): HP4263B or equal
			ESR Tester.
5	Leakage Current (DCL)	Measured after 5 minutes application of rated	a. Test equipment: TH2686 or equivalent I_0 test
		voltage reading, $I_0 \leq 0.01 \times C_{R*}U_R$ or $0.5 \mu A$	equipment.
		whichever is greater (20 °C)	b. Measurement method:
		(Refer to Appendix A)	1) The chip shall be charged for 5min at most
			at rated voltage at 25°C.
			2) Current decreases as time passes, but gets
			into a stable situation at a certain value
			which shall be recorded as $\mathbf{I}_{0.}$
6	Solderability	a. No visible mechanical damage.	a. Solder temperature: 235±2C°
		b. Wetting shall exceed 95% coverage.	b. Duration: 3 sec.
		c. The less 5% of area is permitted to contain	c. Solder: Sn/3.0Ag/0.5Cu
		a few defect, such as pinholes, holes,	d. Flux: 25% Resin and 75% ethanol in weight.
		un-soaking or poor soaking area which do	
		not gather together.	





8 Cautions for Using Tantalum Capacitor

No.	Process	Condition						
1	Operating condition	1-1 Storage						
	(Storage ,Transportation)	 a. The solderability of the external electrode may be deteriorated if packages are stored where they are exposed to high humidity. Package must be stored at 40°C or less and 70% RH or less. b. The solderability of the external electrode may be deteriorated if packages are stored where they are exposed to dust of harmful gas (e.g. HCl, sulfurous gas of H2S). c. Packaging material may be deformed if package are stored where they are exposed to heat of direct sunlight. d. The minimum package and polyethylene package should not be opened until the capacitors are used; once they were opened, use the capacitors as soon as possible. e. Solderability specified shall be guaranteed for 3 months from the date of delivery on condition that they are stored at the environment specified in Clause 4. For those parts, which passed more than 3 months shall be checked solder-ability before use. 1-2 Transportation Package should not be destroyed or get wet. 						
2	Precautionary measures	 a. Put on electrostatic prevention to avoid ESD. b. Equipments involved in capacitor application (such as soldering tip and tester) should be well grounded. c. Avoid touching electrode directly by hand or metal (such as metal table). 						
3	Circuit design	3-1 Operating temperature -55 degrees C to +125 degrees C. 3-2 Operating Voltage \$\$\frac{1}{1000} 1000000000000000000000000000000000000						





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No.	Process	Condition								
3	Circuit design	40 40 46.3 10 46.3 10 46.3 10 46.3 10 46.3 10 46.3 10 10 10 10 10 10 10 10 10 10								
		 3-3 Reverse Voltage Since tantalum capacitor has polarity, do not apply a reverse voltage to it. Do not apply capacitor to circuit which only has alternating current. a、 If there is no alternation, applying a low reverse voltage which is listed below to capacitor in a sl time is approved: b、 In principle, testing a circuit with tantalum capacitor or capacitor itself by using a resistor gear of millimeters in ignorance of polarity is forbidden. c、 During measurement and application, if the tantalum capacitor is subjected to an undesirable re voltage due to carelessness, please dispose it, even if its electrical characteristics are still qualified 								
		Temp. Max. Reverse voltage in a short time								
		25°C $10\% U_R$ (rated voltage), working voltage to maximum of 1.0v.								
		85°C 3% U_R (rated voltage) ,working voltage to maximum of 0.5v.								
		125°C 1% U_R (rated voltage) ,working voltage to maximum of 0.1v.								
		 3-4 Ripple Voltage Please use the capacitor within permissible ripple voltage. a. The sum of DC bias voltage and the maximum AC branch voltage should not exceed rated voltage during operation. b. The sum of negative peak AC value and DC bias voltage should not exceed the specified revers voltage. c. Ripple current applied to capacitor will generate active power loss, which will raise the rate of the failure caused by heat due to self-heat generation of capacitor. Therefore, ripple current and permissible power loss must be in control. 								
4	Mounting	In mounting, if the capacitor has underwent excessive mechanical and thermal shock which may cause deterioration of electrical characteristics, open circuits and short circuits, please confirm the practical mounting conditions before usage.								
5	Soldering	Profile Feature Pb-free Assembly SnPb Assembly								
		Pre-heating 50~165C° 50~165C° 90~120sec. 90~120sec. 90~120sec.								
		Max. Peak Temperature 250~260C° 240~250C°								
		Time of wave 3~5sec. 3~5sec. (max. 10sec.) (max. 10sec.)								
		The upper side temperature of the board should not exceed +150C°.								



Tantalum Capacitors Specification





9 Packaging



Figure Dimension of tape and reel

Symbol	Dim (nensions mm)	Symbol	Dimensions (mm)
Р	12	2.7±1.0	D	4.0±0.2
Po	12.7±0.3		Т	0.5±0.2
\\/	10	+1.0	Δh	0±0.2
VV	10	-0.5	H1	16±0.5
Wo	5 Minimum		S	2.50±0.5,5.00±0.7
LL.	0	+0.75	D.	510+05 285+07
1 12	9	-0.50	Γ1	5.10±0.5, 5.05±0.7
۱۸/	0	+1	D	6 25+0 4
V V 2	0	-0	F 2	0.35±0.4
Н	32.5	Maximum	ΔP	±1.3 Maximum





Appendix A

Rated Volta	Rated Voltage U_R (V)		4	6.3	10	16	25	35	40	50	
Category VoltageU _C (V)			2.5	4	6.3	10	16	20	25	32	
Dimensions (mm)				Conscitance (UE)							
D*H	d	S		Capacitance (µF)							
			3.3	1.5	1	0.68	0.33	0.1	0.1	0.1	
			4.7	2.2	1.5	1	0.47	0.15	0.15	0.15	
			6.8	3.3	2.2	1.5	0.68	0.22	0.22	0.22	
	0.5	2	10	4.7	3.3	2.2	1	0.33	0.33	0.33	
4.4 X 0.5	0.5	2	15	6.8	6.8	3.3	1.5	0.47	0.47	0.47	
			22	10	10	4.7	2.2	0.68	0.68		
			33	15	15	6.8	3.3	1			
				22		10		1.5			
			47	33	22	15	4.7	2.2	1	0.68	
5.0 x 7.5	0.5	2	68	47	33	22	6.8	3.3	1.5	1	
							10	4.7	2.2	1.5	
			100	68	47	33	15	6.8	3.3	2.2	
5.5 x 9.0	0.5	2.5	150	100	68	47	22	10	4.7	3.3	
					100						
6.2	0.5	2.5	220	150	150	68	33	15	6.8	4.7	
6.3 X 10.5	0.5	2.5	330	220		100	47	22	10	6.8	
7.2.42	0.5	-	470	330	220	150	68	33	15	10	
7.2x 12	0.5	5	680	470	330	220	100	47	22	15	
8 .5 x 13	0.5	5		680	470	330	150	68	33	22	

Appendix B

Capacitance	Capacitance change Δ C/C (%)				DC leakage								
Range (µF)	-55C°	+85C°	+125C°	-55C°	+25C°	+85C°	+125C°	+85C°	+125C°				
0.47 ~ 1.0		±10 ±10	+15	6	4		ô						
1.5 ~ 6.8				8	6	:	3						
10~68	+10			10	8	1	.0	81 ₀ ⁽¹⁾	10I ₀				
100 ~ 330						210		12	10	1	2		
470 ~ 680				14	12	1	.4						
> 680				16	14	1	.6						

(1) $I_{\scriptscriptstyle 0}$ refer to initial value of DC leakage current